



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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DEV/MS  
3-21-03

IN RE APPLICATION OF: G. OCKENFUSS et al.

Serial No.: 10/004,142

Filed: February 27, 2003 (1/14/2001) <sup>ESS</sup>

For: STRESS FREE AND THERMALLY STABILIZED  
DIELECTRIC FILTER

Group Art Unit: 2872

Examiner: Arnel Lavarias

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents

Washington, D.C. 20231

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Honorable Sir:

Attached hereto is a substantial equivalent to Form PTO-1449 listing documents believed relevant to the subject application. It is respectfully requested that these documents be considered by the Examiner and initialed copy of each form the return to the undersigned.

This disclosure statement should not be construed as a representation that a search has been made or that no other material information as defined in 37 CFR § 1.56 (a) exists.

It is believed that this disclosure complies with the requirements of 37 CFR §§ 1.56, 1.97, and 1.98, and the Manual of Patents Examining Procedures § 609. If for some reason the Examiner considers otherwise, is respectfully requested that the undersigned be called for the deficiencies can be remedied.

Some of the documents may have markings thereon. No significance is meant to be attached to the markings.

These documents are not necessarily analogous art.

Respectfully submitted:

By:  on 2/27/2003

Edward S. Sherman, Ph.D.

Patent Attorney (Reg. No. 43,115)

3354 Round Barn Boulevard

Suite 303

Santa Rosa, CA 95403

707) 579-0580

707) 332-3645 (mobile)

707) 528- 6015 (fax)

C: Eileen Woodside, Chief Patent Administrator, Intellectual Property Dept., JDS-

Uniphase Corporation

**CERTIFICATE OF MAILING FIRST CLASS MAIL**

I hereby certify that this paper and all enclosures are being deposited with the United States Postal Service as first class mail in an envelope addressed to: The Assistant Commissioner for Patents, Washington, D.C. 20231 on 2/27/2003

Signature of Person Mailing Correspondence: 

Printed Name: Edward S. Sherman